

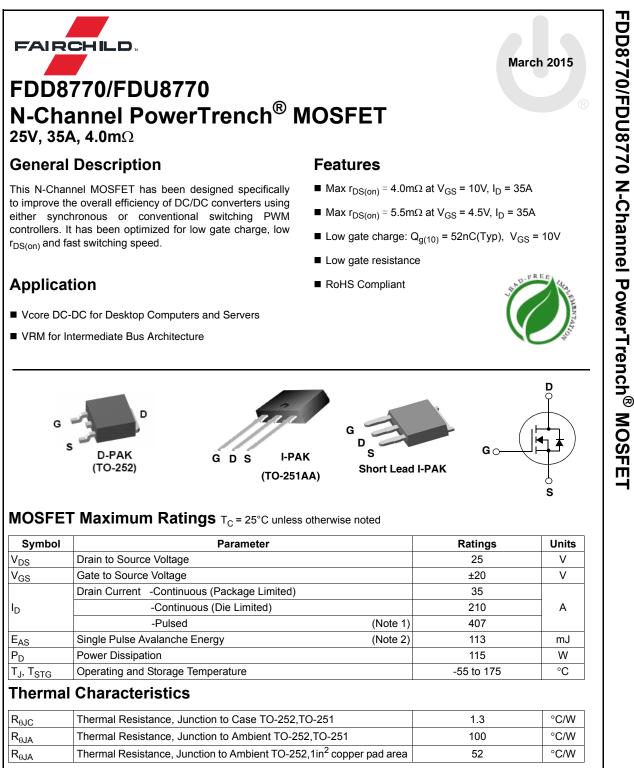
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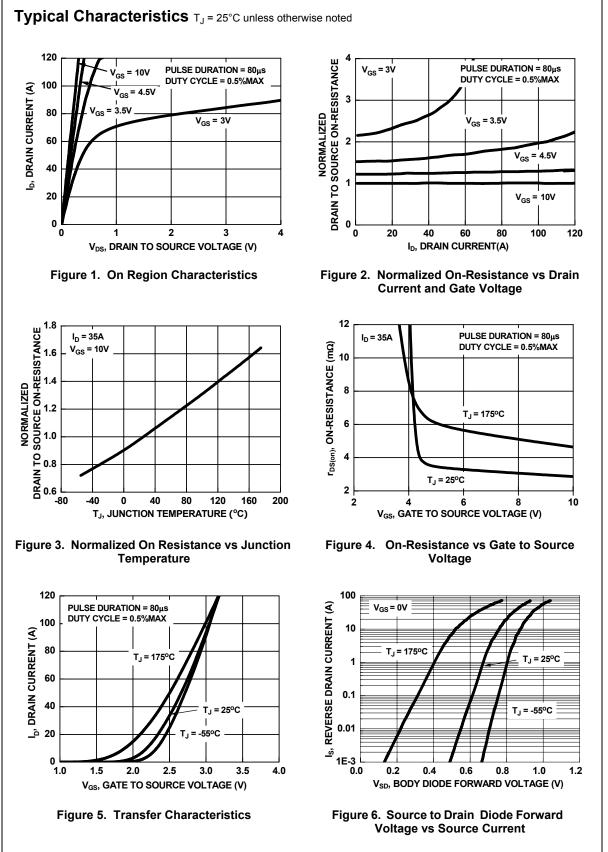
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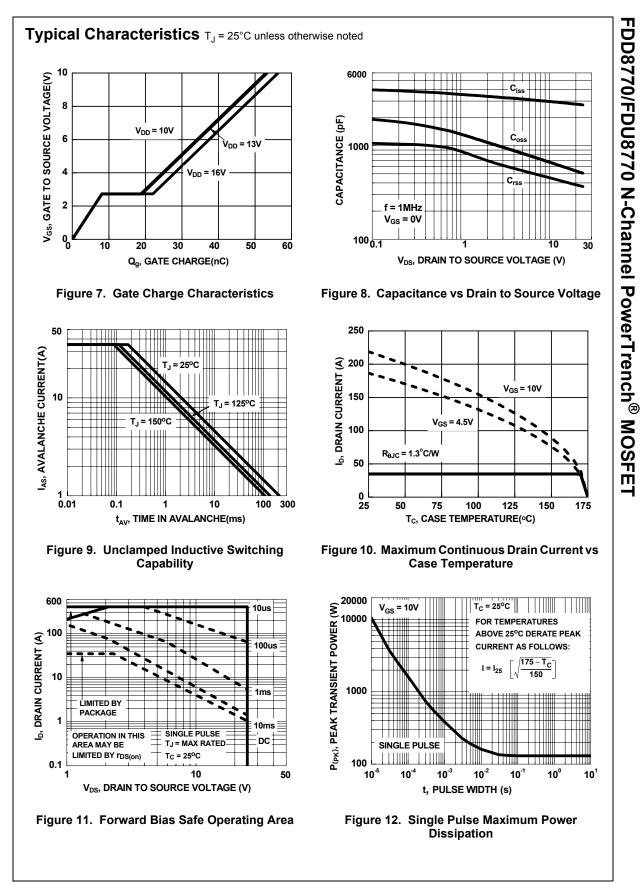


Package Marking and Ordering Information

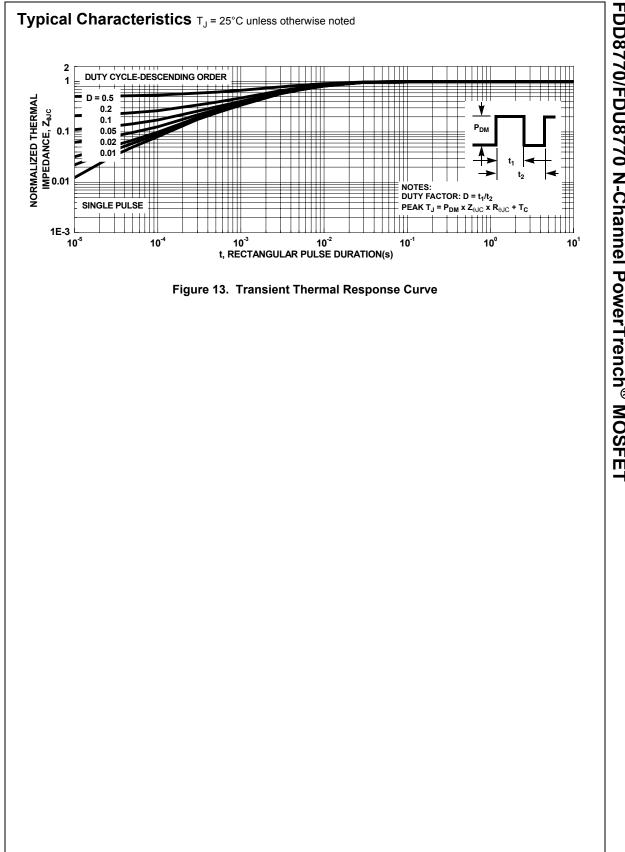
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDD8770	FDD8770	TO-252AA	13"	16mm	2500 units
FDU8770	FDU8770	TO-251AA	N/A(Tube)	N/A	75 units
FDU8770	FDU8770_F071	TO-251AA	N/A(Tube)	N/A	75 units

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					
B _{VDSS}	Drain to Source Breakdown Voltage	I _D = 250μA, V _{GS} = 0V	25			V
ΔB _{VDSS}	Breakdown Voltage Temperature	$I_D = 250 \mu A$, referenced to		10.0		
ΔT_J	Coefficient	25°C		13.6		mV/°C
I _{DSS}	Zero Gale Voltage Drain Current	V _{DS} = 20V,			1	μA
055		$V_{GS} = 0V$ $T_J = 150^{\circ}C$			250	50 .
I _{GSS}	Gate to Source Leakage Current	V _{GS} = ±20V			±100	nA
On Chara	cteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \mu A$	1.2	1.6	2.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_{.l}}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250\mu A$, referenced to $25^{\circ}C$		-5.9		mV/°C
r _{DS(on)} Drain to Source On R		V _{GS} = 10V, I _D = 35A		3.3	4.0	-
	Desig to Course On Desigtance	V _{GS} = 4.5V, I _D = 35A		4.0	5.5	
	Drain to Source On Resistance	$V_{GS} = 10V, I_D = 35A$ T ₁ = 175°C		4.8	5.9	_ mΩ
C _{oss}	Output Capacitance Reverse Transfer Capacitance	V _{DS} = 13V, V _{GS} = 0V, f = 1MHz		685 450	915 675	pF pF
C _{iss}	Input Capacitance	$V_{De} = 13V V_{Ce} = 0V$		2795	3720	pF
C _{rss}					675	
R _g	Gate Resistance	f = 1MHz		1.5		Ω
Switching	g Characteristics					
t _{d(on)}	Turn-On Delay Time	V 40V/L 05A		10	20	ns
t	Rise Time	V _{DD} = 13V, I _D = 35A V _{GS} = 10V, R _{GS} = 5Ω		12	22	ns
ዣ	Turn-Off Delay Time	VGS 100, NGS 022		49	78	ns
	Taill Oli Belay Tille			25	40	ns
t _{d(off)} t _f	Fall Time					nC
t _{d(off)} t _f Q _g	Fall Time Total Gate Charge	$V_{GS} = 0V \text{ to } 10V$ $V_{DD} = 13V$		52	73	
t _{d(off)} t _f Q _g Q _g	Fall Time Total Gate Charge Total Gate Charge	$V_{\text{DD}} = 0V \text{ to } 5V$ $V_{\text{DD}} = 13V$		29	73 41	nC
Q _{gs}	Fall Time Total Gate Charge Total Gate Charge Gate to Source Gate Charge			29 8.1	-	nC
t _{d(off)} t _f Q _g Q _g Q _{gs}	Fall Time Total Gate Charge Total Gate Charge	$V_{GS} = 0V \text{ to } 5V$ $V_{DD} = 13V$ $I_D = 35A$		29	-	
$t_{d(off)}$ t_{f} Q_{g} Q_{gs} Q_{gd}	Fall Time Total Gate Charge Total Gate Charge Gate to Source Gate Charge	$V_{GS} = 0V \text{ to } 5V$ $V_{DD} = 13V$ $I_D = 35A$		29 8.1	-	nC
t _{d(off)} Q _g Q _g Q _{gs} Q _{gd} Drain-Sou	Fall Time Total Gate Charge Total Gate Charge Gate to Source Gate Charge Gate to Drain "Miller"Charge urce Diode Characteristics	$V_{GS} = 0V \text{ to } 5V$ $V_{DD} = 13V$ $I_D = 35A$		29 8.1	-	nC nC
$t_{d(off)}$ t_{f} Q_{g} Q_{gs} Q_{gd} Drain-Sou	Fall Time Total Gate Charge Total Gate Charge Gate to Source Gate Charge Gate to Drain "Miller"Charge	$V_{GS} = 0V \text{ to } 5V$ $V_{DD} = 13V$ $I_D = 35A$ $I_g = 1.0mA$		29 8.1 11	41	nC
t _{d(off)} t _f Q _g Q _g Q _{gs} Q _{gd}	Fall Time Total Gate Charge Total Gate Charge Gate to Source Gate Charge Gate to Drain "Miller"Charge urce Diode Characteristics	$V_{GS} = 0V \text{ to } 5V$ $I_D = 35A$ $I_g = 1.0mA$ $V_{GS} = 0V, I_S = 35A$		29 8.1 11 0.84	41	nC nC





FDD8770/FDU8770 Rev. 1.2





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